## **BGA Heat Sink - High Performance ASIC Cooling**





ATS Part#: ATS-56011-C4-R0

Description: 57.50 x 57.50 x 12.50 mm BGA Heat Sink - High Performance ASIC Cooling

Heat Sink Type: ASIC Cooling
Heat Sink Attachment: Thermal Tape

Equivalent Part Number: N/A

## **Features & Benefits**

- maxiFLOW™ design features a low profile, spread fin array that maximizes surface area for more effective convection (air) cooling
- · Designed specifically for ASIC package and their unique cooling requirements

## **Thermal Performance**

AIR VELOCITY		@200 LFM 1.0 M/S	@300 LFM 1.5 M/S	@400 LFM 2.0 M/S	@500 LFM 2.5 M/S	@600 LFM 3.0 M/S	@700 LFM 3.5 M/S	@800 LFM 4.0 M/S
THERMAL RESISTANCE	Unducted Flow	2.3 °C/W	1.8 °C/W	1.3 °C/W	1.2 °C/W	1 °C/W	0.8 °C/W	0.7 °C/W
	Ducted Flow	1.1	N/A	N/A	N/A	N/A	N/A	N/A

## **Product Detail**

Schematic Image	Dimension A	Dimension B	Dimension C	Dimension D	TIM	Finish
	57.50 mm	57.50 mm	12.50 mm	70 mm	NO TIM	BLACK-ANODIZED
*Image above is for illustration purpose only.	<ul> <li>Dimension</li> <li>Thermal application</li> <li>ATS reserve performa</li> <li>ATS certification</li> </ul>	erves the right to up	theight from the book reprovided for reference date or change its particle ink assembly is Rol	erence only. Actual poroducts without not	performance	may vary by



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